| Electronic Patent Application Fee Transmittal | | | | | | | |
|---|--|----------|----------|--------|-------------------------|--|--|
| Application Number: | 09590646 | | | | | | |
| Filing Date: | 08-Jun-2000 | | | | | | |
| Title of Invention: | Reinforced, self-aligning conductive structures for semiconductor device components and methods for fabricating same | | | | | | |
| First Named Inventor/Applicant Name: | Vernon M. Williams | | | | | | |
| Filer: | Brick Glenn Power/Deidra Pfeil | | | | | | |
| Attorney Docket Number: | 4210US (99-0173) | | | | | | |
| Filed as Large Entity | | | | | | | |
| Utility under 35 USC 111(a) Filing Fees | | | | | | | |
| Description | | Fee Code | Quantity | Amount | Sub-Total in USD(\$) | | |
| Basic Filing: | | | | | | | |
| Pages: | | | | | | | |
| Claims: | | | | | | | |
| Independent claims in excess of 3 | -/ | 1201 | 3 | 220 | 660 | | |
| Miscellaneous-Filing: | | | | | | | |
| Petition: | | | | | | | |
| Patent-Appeals-and-Interference: | | | | | | | |
| Post-Allowance-and-Post-Issuance: | | | | | | | |
| Extension of Time: | | | | | | | |

| Description | Fee Code | Quantity | Amount | Sub-Total in USD(\$) |
|----------------|-------------------|----------|--------|-------------------------|
| Miscellaneous: | | | | |
| | Total in USD (\$) | | | 660 |